05-01-2003 4-22-03 RECOF U.S. DEPARTMENT OF COMMERCE Ferm PTO-1595 U.S. Patent and Trademark Office (R.v. 10/02) OMB No. 0651-0027 (exp. 6/30/2005) 102435519 ab settings ⇒ ⇒ ⇒ To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies) Name of conveying party(ies): Name: Texas Instruments Incorporated Changfeng Xia Internal Address: Acditional name(s) of conveying party(ies) attached? Types XXNo 3 Nature of conveyance: Merger XX Assignment Street Address: P.O. Box 655474. MS3999 Security Agreement Change of Name 75265 Dallas, TX Other City:____ State: Zip: Execution Date: April 9, 2003 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: 4/22/03 A. Patent Application No.(s) B. Patent No.(s) 10,420228 Additional numbers attached? Yes XXVo 6. Total number of applications and patents involved: 1 E. Name and address of party to whom correspondence concerning document should be mailed: 7. Total fee (37 CFR 3.41).....\$ 40.00 Name: Jacqueline J. Garner XX Enclosed Internal Address: Authorized to be charged to deposit account 8. Deposit account number: Street Address: Texas Instruments Incorporated P.O. Box 655474, MS 3999 (Attach duplicate copy of this page if paying by deposit account) City: Dallas State: TX Zip: 75265

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Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

RUSSELL HOLLOWAY

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 2 Mail documents to be recorded with required cover sheet information to:

issioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

PATENT REEL: 014008 FRAME: 0138

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having is vented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the S ate of Delaware, having a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, P.O. Box 655474, MS 3999, Dallas, Texas 75265, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell a id assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and I rademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said I EXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign plats to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	METHOD AND APPARATUS FOR REMOVING POLYMER RESIDUE FROM SEMICONDUCTOR WAFER EDGE AND BACK SIDE		
SIGNATURE OF INVENTOR AND NAME	Chang feg Xico	(2)	(3)
DATE	April 09, 2003		
RESIDENCE (City, State)	Plano, Texas		
DATE APPLICATION EXECUTED	April 9, 2003		

I fter recordation, please return Assignment to:

RECORDED: 04/22/2003

Jacqueline J. Garner
Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, TX 75265

PATENT REEL: 014008 FRAME: 0139